

1.5V Drive Nch MOSFET

TT8K1

Structure

Silicon N-channel MOSFET

Features

- 1) Low On-resistance.
- 2) High power package.
- 3) 1.5V drive.

Application

Switching

Packaging specifications

	Package	Taping
Type	Code	TR
	Basic ordering unit (pieces)	3000
TT8K1		0

● Absolute maximum ratings (Ta = 25°C)

<It is the same ratings for the Tr1 and Tr2.>

Parameter		Symbol	Limits	Unit
Drain-source voltage		V_{DSS}	20	V
Gate-source voltage		V_{GSS}	±10	V
Drain current	Continuous	I_D	±2.5	Α
	Pulsed	I _{DP} *1	±10	Α
Source current (Body Diode)	Continuous	Is	0.8	Α
	Pulsed	I _{sp} *1	10	Α
Power dissipation		P _D *2	1.25	W / TOTAL
		ıр	1.0	W / ELEMENT
Channel temperature		Tch	150	°C
Range of storage temperature		Tstg	-55 to +150	°C

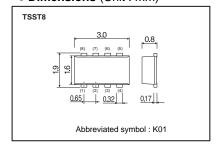
^{*1} Pw≤10µs, Duty cycle≤1%

Thermal resistance

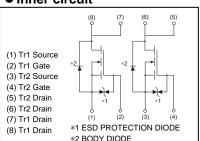
Parameter	Symbol	Limits	Unit
Channel to Ambient	Rth (ch-a)*	100	°C / W /TOTAL
Charmer to Ambient	Kiii (Gii-a)	125	°C/W/ELEMENT

^{*}Mounted on a ceramic board.

● Dimensions (Unit : mm)



• Inner circuit



^{*2} Mounted on a ceramic board.

● Electrical characteristics (Ta = 25°C)

<It is the same characteristics for the Tr1 and Tr2.>

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Gate-source leakage	I _{GSS}	1	-	±10	μA	$V_{GS}=\pm 10V$, $V_{DS}=0V$
Drain-source breakdown voltage	V _{(BR)DSS}	20	-	-	V	$I_D=1mA, V_{GS}=0V$
Zero gate voltage drain current	I _{DSS}	1	-	1	μA	V _{DS} =20V, V _{GS} =0V
Gate threshold voltage	V _{GS (th)}	0.3	1	1	V	V_{DS} =10V, I_{D} =1mA
Static drain-source on-state resistance	R _{DS (on)}	1	52	72	mΩ	I _D =2.5A, V _{GS} =4.5V
		1	65	90		I _D =2.5A, V _{GS} =2.5V
		1	85	120		I _D =1.2A, V _{GS} =1.8V
		1	100	140		I _D =0.5A, V _{GS} =1.5V
Forward transfer admittance	I Y _{fs} I*	2.7	1	-	S	I _D =2.5A, V _{DS} =10V
Input capacitance	C _{iss}		260	-	pF	V _{DS} =10V
Output capacitance	C _{oss}	1	65	-	pF	V _{GS} =0V
Reverse transfer capacitance	C _{rss} *		35	-	pF	f=1MHz
Turn-on delay time	t _{d(on)} *	1	9	-	ns	I _D =1.2A, V _{DD} ≒10V
Rise time	t _r *	1	17	-	ns	V _{GS} =4.5V
Turn-off delay time	t _{d(off)} *	1	28	-	ns	R _L ≒8.3Ω
Fall time	t _f *	-	17	-	ns	$R_G=10\Omega$
Total gate charge	Q _g *	-	3.6	-	nC	I _D =2.5A, V _{DD} ≒10V
Gate-source charge	Q _{gs} *	-	0.7	-	nC	V _{GS} =4.5V R _L ≒ 4Ω
Gate-drain charge	Q _{gd} *	-	0.6	-	nC	$R_G=10\Omega$

^{*}Pulsed

●Body diode characteristics (Source-Drain) (Ta = 25°C)

<It is the same characteristics for the Tr1 and Tr2.>

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Forward Voltage	V_{SD}	-	-	1.2	V	I _s =2.5A, V _{GS} =0V

^{*}Pulsed

• Electrical characteristic curves

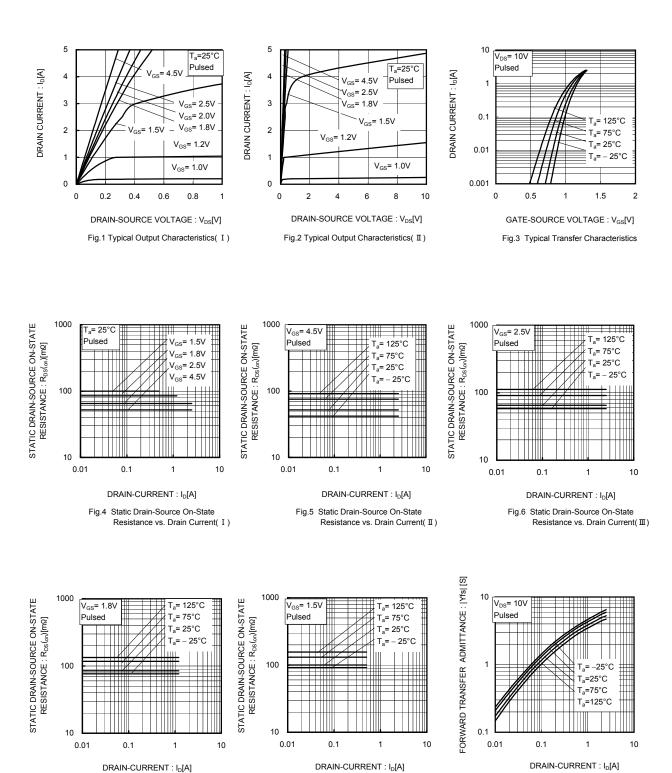


Fig.7 Static Drain-Source On-State

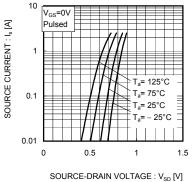
Resistance vs. Drain Current(IV)

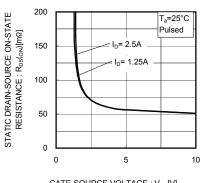
Fig.9 Forward Transfer Admittance

vs. Drain Current

Fig.8 Static Drain-Source On-State

Resistance vs. Drain Current(V)





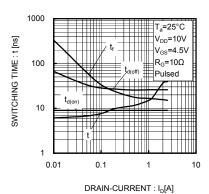
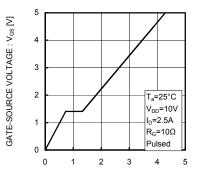
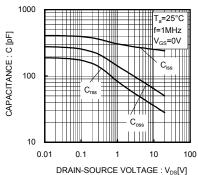


Fig.10 Reverse Drain Current vs. Sourse-Drain Voltage

GATE-SOURCE VOLTAGE : $V_{GS}[V]$ Fig.11 Static Drain-Source On-State Resistance vs. Gate Source Voltage

Fig.12 Switching Characteristics





TOTAL GATE CHARGE : Qg [nC]

Fig.13 Dynamic Input Characteristics

Fig.14 Typical Capacitance vs. Drain-Source Voltage

Measurement circuits

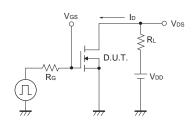


Fig.1-1 Switching time measurement circuit

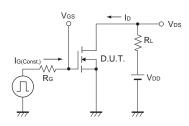


Fig.2-1 Gate charge measurement circuit

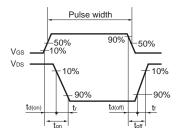


Fig.1-2 Switching waveforms

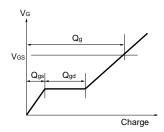


Fig.2-2 Gate Charge Waveform

Notice

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